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Federal Communications Commission

DA 97-1212

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Before the
Federal Communications Commission
Washington, D.C. 20554

In the Matter of)
)
Amendment of Parts 2 and 15 of the) ET Docket 95-19
Commission's Rules to Deregulate the)
Equipment Authorization Requirements)
for Digital Devices)
)

ORDER

Adopted: June 10, 1997

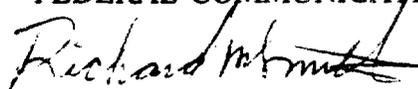
Released: June 10, 1997

By the Office of Engineering and Technology:

1. This action extends the effective date of the transition provision of Section 15.37(g) by 90 days from June 19, 1997 to September 17, 1997. Section 15.37(g) requires that the manufacture and importation of Central Processing Unit (CPU) boards and power supplies designed to be used with personal computers, cease on or before June 19, 1997 unless these products have been authorized under a Declaration of Conformity or a grant of certification. The Commission received three Petitions for Reconsideration filed by the Information Technology Industry Council, Hewlett-Packard Company, and Intel Corporation in the above captioned matter. The Commission expects to act on these petitions in the near future. We recognize that manufacturers are concerned about finalizing their designs until the issues raised in the petitions are resolved. An extension of 90 days will permit the Commission to act on the petitions and should allow manufacturers sufficient time to implement any changes to the rules. Accordingly, IT IS ORDERED, that the effective date of Section 15.37(g) is extended to September 17, 1997.

2. This action is taken pursuant to authority found in Sections 4 (i) and 303 of the Communications Act of 1934, as amended, 47 U.S.C. §§ 154 (i) and 303; and pursuant to Sections 0.31 and 0.241 of the Commission's Rules, 47 C.F.R. §§ 0.31 and 0.241. For further information contact the Office of Engineering and Technology, Anthony Serafini at (202) 418-2456 or Neal McNeil (202) 418-2408.

FEDERAL COMMUNICATIONS COMMISSION



Richard M. Smith

Chief

Office of Engineering and Technology